SEQUI SEMICONDUCTOR

Z-POWER LED Series

Technical Datasheet for F50380



Z-Power series is designed for high current operation and high flux output applications.

Z-Power LED's thermal management perform exceeds other power LED solutions.

It incorporates state of the art SMD design and Thermal emission material.

Full color Z-Power LED is the first full color package, using 3 RGB power chips and rendering 7colors.

In case of the full color product used in architectural lighting or decoration, it emits 7colors in one package so that it can render a clear mixed color when it is mixed with other colors.

Features

- Super high Flux output and high Luminance
- Designed for high current operation
- Low thermal resistance
- SMT solderbility
- Lead Free product
- RoHS compliant

Application

- · Mobile phone flash
- Automotive interior / exterior lighting
- Automotive signal lighting
- Automotive forward lighting
- General Torch
- Architectural lighting
- LCD TV / Monitor Backlight
- Projector light source
- Traffic signals
- Task lighting
- Decorative / Pathway lighting
- Remote / Solar powered lighting
- · Household appliances





Full Code of Z-Power LED Series

Full code form : $X_1 X_2 X_3 X_4 X_5 X_6 - X_7 X_8 - X_9 X_{10} X_{11} X_{12} X_{13} X_{14}$

1. Part Number

- X₁: Color
- X₂: Z-Power LED series number
- X₃: LENS type
- X_4 : Chip quantity (or Power Dissipation)
- X_5 : Package outline size
- X₆: Type of PCB

2. Internal Number

- X₇
- X₈

3. Code Labeling

- X₉: Red Luminous flux
- X₁₀: Green Luminous flux
- X_{11} : Blue Luminous flux
- X₁₂ : Red Dominant wavelength
- X_{13} : Green Dominant wavelength
- X_{14} : Blue Dominant wavelength

4. Sticker Diagram on Reel & Aluminum Vinyl Bag

PART NO. : $X_1 X_2 X_3 X_4 X_5 X_6 - X_7 X_8$

I BENENI ETEK ENDAKRISI. INKENINE MERINIK BILANG ENIKAN ENIKERIA BEREN IBARAN IRA

QUANTITY: ###

LOT NUMBER: ###########

TURNIN BURG BIRK BERK TERRITAK REKUMA BURKA TURNIN BURKA BURKA BURKA BURKA BURKA BURKA BURKA BURKA BURKA BURKA

BIN CODE: X₉ X₁₀ X₁₁ X₁₂ X₁₃ X₁₄



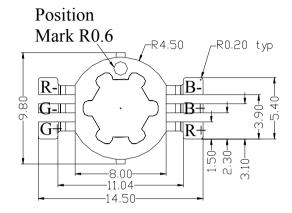


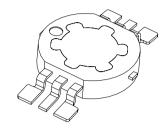




Outline Dimensions

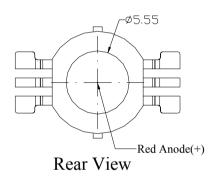
1. Emitter Type

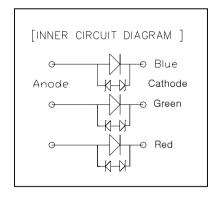




Isometric View

R0.20 R0.20 R1.50 R0.20





Notes:

- 1. All dimensions are in millimeters. (tolerance : ± 0.2)
- 2. Scale: none
- 3. Slug of package is connected to anode of Red.

*The appearance and specifications of the product may be changed for improvement without notice.



Characteristics for Dome type Z-Power LED

1. Electro-Optical Characteristics (Red, Green and Blue All color in use)

1-1 Electro-Optical characteristics at T_A=25°C

Parameter	Sumah al		lle:t		
Parameter	Symbol	Min	Тур	Max	Unit
Total Luminous Flux ^[1]	$\Phi_{V}^{[2]}$	41.5	78 (58)[3]	-	lm
Forward Voltage [4]	$V_{\scriptscriptstyle F}$	-	R:2.5 B:3.4 G:3.7	-	V
Forward Current	I_{F}	R,G,B:350			mA
View Angle ^[5]	2⊝ 1/2	130			deg.
Thermal Resistance ^[6]	R⊖ _{J-B}	R: 30, G: 20, B: 19 @ R, G, B 350mA			°C /W

1-2 Absolute Maximum Ratings

Parameter	Symbol		Value	Unit	
		Red	Green	Blue	Onit
Total Forward Current [8]	${ m I}_{\sf F}$	0.4	0.4	0.4	А
Power Dissipation	P_{D}	1.2	1.6	1.6	W
Junction Temperature	T _j	100	125	125	oC
Operating Temperature	T_{opr}	-40 ~ +85		oC	
Storage Temperature	T_{stg}	-40 ~ +120			oC
ESD Sensitivity [7]	-	±10,000V HBM			-

*Notes:

- [1] SSC maintains a tolerance of $\pm 10\%$ on flux and power measurements.
- [2] Φ_V is the total luminous flux output as measured with an integrated sphere under 350 mA red,green and blue.
- [3] Reference white balance current condition(I_F=R:170, G:370, B:150 mA)
- [4] A tolerance of $\pm 0.1V$ on forward voltage measurements
- [5] Viewing angle is the reference condition.
- [6] $R\theta_{J-B}$ is measured with a SSC metal core pcb.(25 °C \leq T $_{J} \leq$ 110 °C) Insulation voltage of Metal PCB is 6.5kVAC
- [7] It is included the zener chip to protect the product from ESD. (bidirectional zener diode, Vb = 5.6V)

-----Caution-----

Please do not drive at rated current more than 5 sec. without proper heat sink





2. Blue

2-1 Electro-Optical characteristics at I_F=350mA, T_A=25°C

Parameter	Symbol	Value			Unit
		Min	Тур	Max	Oilit
Luminous Flux ^[1]	$\Phi_{V}^{[2]}$	6.0	6.8	-	lm
Dominant Wavelength ^[3]	λ_{D}	455	460	467	nm
Forward Voltage ^[4]	V_{F}	3.0	3.5	4.0	V
View Angle ^[5]	2⊝ 1/2	130			deg.
Thermal Resistance ^[6]	$R\Theta_{J-B}$	12.5			°C /W

2-2 Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	${ m I}_{\sf F}$	0.4	А
Power Dissipation	P _D	1.6	W
Junction Temperature	T _j	125	oC
Operating Temperature	T_{opr}	-40 ~ +85	oC
Storage Temperature	T_{stg}	-40 ~ +120	oC
ESD Sensitivity [7]	-	±10,000V HBM	-

*Notes:

- [1] SSC maintains a tolerance of $\pm 10\%$ on flux and power measurements.
- [2] Φ_V is the total luminous flux output as measured with an integrated sphere.
- [3] Dominant wavelength is derived from the CIE 1931 Chromaticity diagram. A tolerance of ± 1.0 nm for dominant wavelength
- [4] A tolerance of $\pm 0.1V$ on forward voltage measurements
- [5] Viewing angle is the reference condition.
- [6] $R\Theta_{J-B}$ is measured with a SSC metal core pcb.(25 °C \leq T $_{J} \leq$ 110 °C) Insulation voltage of Metal PCB is 6.5kVAC
- [7] It is included the zener chip to protect the product from ESD. (bidirectional zener diode, Vb = 5.6V)

-----Caution-----

- 1. Please do not drive at rated current more than 5 sec. without proper heat sink
- 2. Blue power light sources represented here are IEC825 Class 2 for eye safety





3. Green

3-1 Electro-Optical characteristics at I_F=350mA, T_A=25°C

Parameter	Symbol	Value			Unit
		Min	Тур	Max	Unit
Luminous Flux [1]	Φ _V ^[2]	32	38	-	lm
Dominant Wavelength ^[3]	λ_{D}	523	533	540	nm
Forward Voltage ^[4]	V_{F}	3.0	3.5	4.0	V
View Angle ^[5]	2⊝ 1/2		130		deg.
Thermal Resistance ^[6]	R⊖ _{J-B}		13		°C /W

3-2 Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	${ m I}_{\sf F}$	0.4	А
Power Dissipation	P _D	1.6	W
Junction Temperature	T _j	125	oC
Operating Temperature	T_{opr}	-40 ~ +85	oC
Storage Temperature	T_{stg}	-40 ~ +120	oC
ESD Sensitivity [7]	-	$\pm 10,000$ V HBM	-

*Notes:

- [1] SSC maintains a tolerance of $\pm 10\%$ on flux and power measurements.
- [2] Φ_V is the total luminous flux output as measured with an integrated sphere.
- [3] Dominant wavelength is derived from the CIE 1931 Chromaticity diagram. A tolerance of ± 1.0 nm for dominant wavelength
- [4] A tolerance of $\pm 0.1V$ on forward voltage measurements
- [5] Viewing angle is the reference condition.
- [6] $R\Theta_{J-B}$ is measured with a SSC metal core pcb.(25 °C \leq T $_{J} \leq$ 110 °C) Insulation voltage of Metal PCB is 6.5kVAC
- [7] It is included the zener chip to protect the product from ESD. (bidirectional zener diode, Vb = 5.6V)

-----Caution-----

Please do not drive at rated current more than 5 sec. without proper heat sink





4. Red

4-1 Electro-Optical characteristics at I_F=350mA, T_A=25°C

Parameter	Symbol	Value			Unit
		Min	Тур	Max	Onit
Luminous Flux [1]	$\Phi_{V}^{[2]}$	23	32	ı	lm
Dominant Wavelength ^[3]	λ_{D}	617	622	629	nm
Forward Voltage ^[4]	V_{F}	2.0	2.5	3.0	V
View Angle ^[5]	2⊝ 1/2		130		deg.
Thermal Resistance ^[6]	R⊖ _{J-B}		18		°C /W

4-2 Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	${ m I}_{\sf F}$	0.4	А
Power Dissipation	P_{D}	1.2	W
Junction Temperature	T _j	100	oC.
Operating Temperature	T _{opr}	-40 ~ +85	oC
Storage Temperature	T _{stg}	-40 ~ +120	oC
ESD Sensitivity [7]	-	±10,000V HBM	-

*Notes:

- [1] SSC maintains a tolerance of $\pm 10\%$ on flux and power measurements.
- [2] Φ_V is the total luminous flux output as measured with an integrated sphere.
- [3] Dominant wavelength is derived from the CIE 1931 Chromaticity diagram. A tolerance of ± 1.0 nm for dominant wavelength
- [4] A tolerance of $\pm 0.1V$ on forward voltage measurements
- [5] Viewing angle is the reference condition.
- [6] $R\Theta_{J-B}$ is measured with a SSC metal core pcb.(25 °C \leq T $_{J} \leq$ 110 °C) Insulation voltage of Metal PCB is 6.5kVAC
- [7] It is included the zener chip to protect the product from ESD. (bidirectional zener diode, Vb = 5.6V)

-----Caution-----

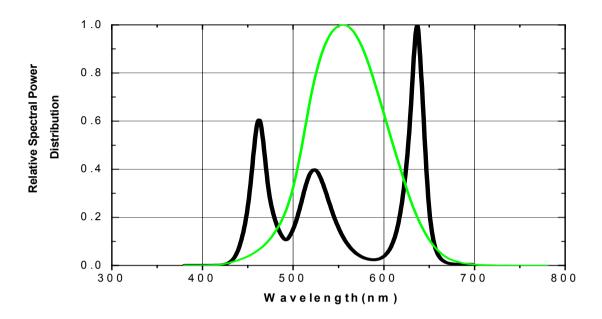
Please do not drive at rated current more than 5 sec. without proper heat sink



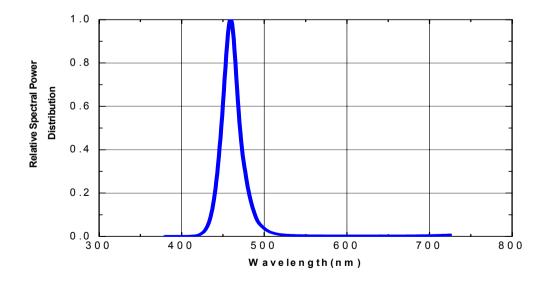


Color spectrum, T_A=25°C

1. White (I_F=R:170, G:370, B:150 mA for the reference condition)

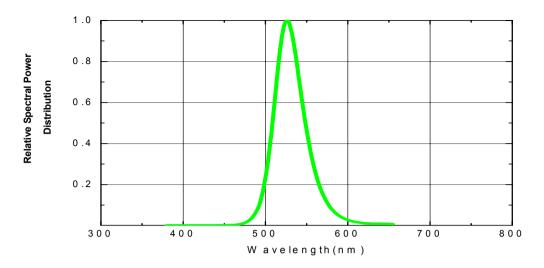


2. Blue (I_F=350mA)

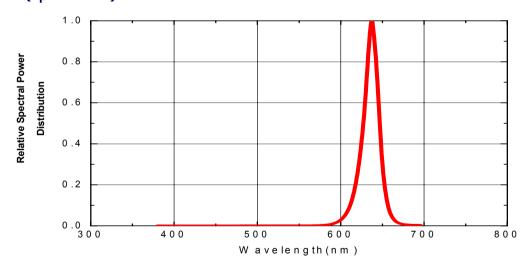




3. Green (I_F=350mA)



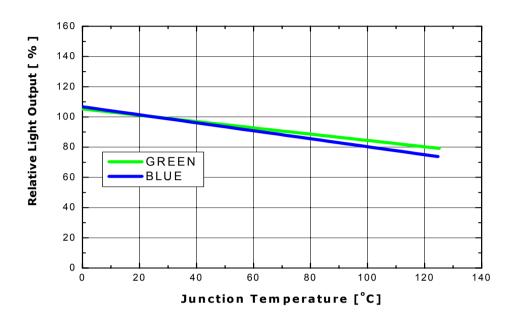
4. Red (I_F=350mA)

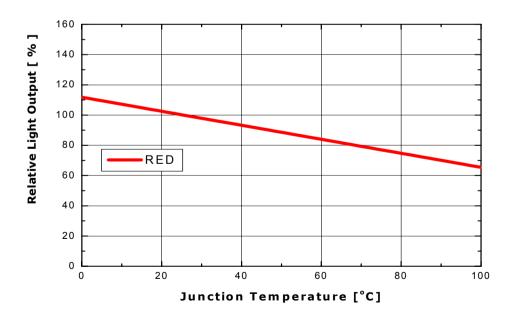




Light Output Characteristics

1. Relative Light Output vs. Junction Temperature at $I_F=350$ mA, $T_A=25$ °C

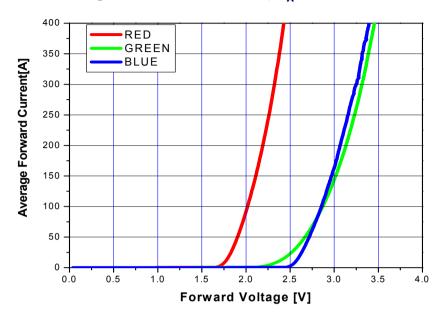




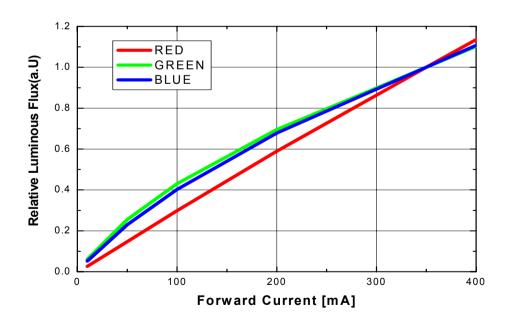


Forward Current Characteristics

1. Forward Voltage vs. Forward Current, $T_A = 25 \,^{\circ}$

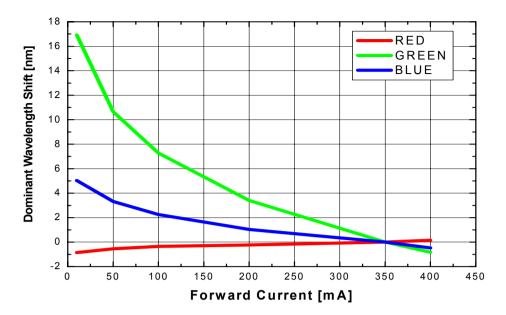


2. Forward Current vs. Normalized Relative Luminous Flux, $T_A = 25 \,^{\circ}$ C



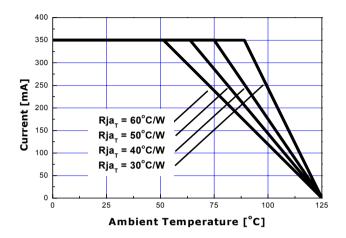


3. Forward Current Vs Wavelength shift, $T_A = 25 ^{\circ}$

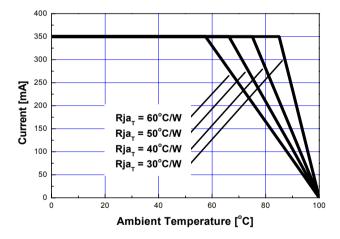


Ambient Temperature vs Allowable Forward Current

1. Blue, Green (T_{JMAX} = 125 °C)



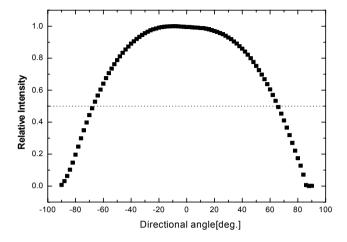
2. Red (T_{JMAX} = 100 °C)



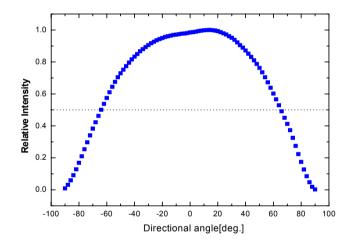


Typical Emitter Type Radiation pattern for the reference condition

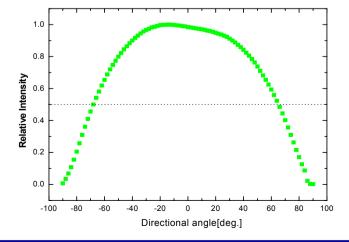
1. White



2. Blue, Red



3. Green

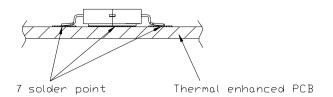


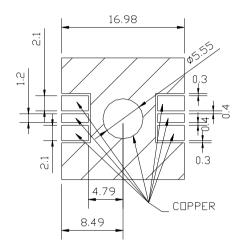


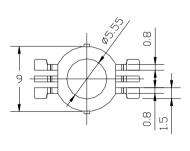


Recommended Soldering

Solder pad







Paste thickness: 0.2mm

Note:

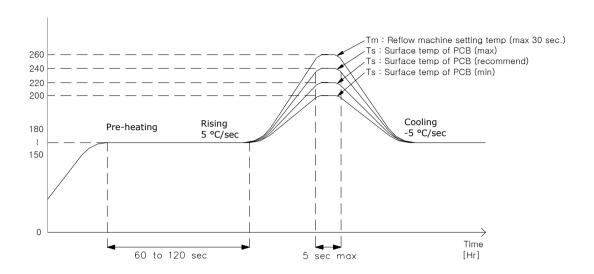
- 1. All dimensions are in millimeters. (tolerance : ± 0.2)
- 2. Scale: none
- 3. Slug of package is connected to anode of Red.

*The appearance and specifications of the product may be changed for improvement without notice.



Soldering profile, $T_A = 25^{\circ}C$

1. Reflow Soldering Conditions / Profile



2. Hand Soldering conditions

Lead: Not more than 3 seconds @MAX280℃

Slug: Use a thermal-adhesives

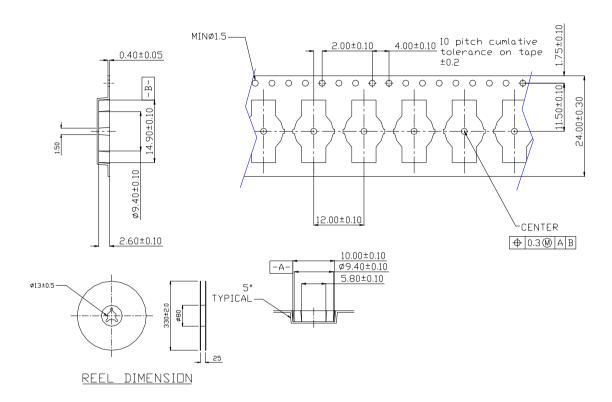
* Caution

- 1. Reflow soldering should not be done more than one time.
- 2. Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, suitable tools have to be used.
- 3. Die slug is to be soldered.
- 4. When soldering, do not put stress on the LEDs during heating.
- 5. After soldering, do not warp the circuit board.
- 6. Recommend to use a convection type reflow machine with $7 \sim 8$ zones.





Emitter Reel Packaging



Note:

- 1. The number of loaded products in the reel is 200ea
- 2. All dimensions are in millimeters
- 3. Scale none
- *The appearance and specifications of the product may be changed for improvement without notice.



Precaution for use

Storage

To avoid the moisture penetration, we recommend storing Z Power LEDs in a dry box (or desiccator) with a desiccant. The recommended storage conditions are Temperature 5 to 30 degrees Centigrade. Humidity 50% maximum.

· Precaution after opening packaging

However LED is correspond SMD, when LED be soldered dip, interfacial separation may affect the light transmission efficiency, causing the light intensity to drop.

Attention in followed.

- a. Soldering should be done right after opening the package(within 24Hrs).
- b. Keeping of a fraction
 - Sealing
 - Temperature : $5 \sim 40^{\circ}$ Humidity : less than 30%
- Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temp. after soldering.
- Please avoid rapid cooling after soldering.
- Components should not be mounted on warped direction of PCB.
- Anti radioactive ray design is not considered for the products listed here in.
- Gallium arsenide is used in some of the products listed in this publication. These products are
 dangerous if they are burned or shredded in the process of disposal. It is also dangerous to
 drink the liquid or inhale the gas generated by such products when chemically disposed.
- This device should not be used in any type of fluid such as water, oil, organic solvent and etc.

 When washing is required, IPA(Isopropyl Alcohol) should be used.
- When the LEDs are illuminating, operating current should be decided after considering the package maximum temperature.
- LEDs must be stored to maintain a clean atmosphere. If the LEDs are stored for 3 months or more after being shipped from SSC, a sealed container with a nitrogen atmosphere should be used for storage.
- The appearance and specifications of the product may be modified for improvement without notice.
- Long time exposure of sunlight or occasional UV exposure will cause lens discoloration.
- The slug is connected to the anode. Therefore, we recommend to isolate the heat sink.
- Attaching LEDs, don't use adhesives to generate organic vapor.





Handling of Silicone resin LEDs

Z-Power LED is encapsulated by silicone resin for the highest flux efficiency. Notes for handling of Silicone resin Z-Power LEDs

- Avoid touching silicone resin parts especially by sharp tools such as Pincette(Tweezers)
- Avoid leaving fingerprints on silicone resin parts.
- Since silicone resin is dust sensitive, Z POWER has to be stored on container with cover.
- When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the surface of the resin must be prevented.
- Covering silicone resin of Z POWER LED with other resin (epoxy, urethane, etc) is not recommended.



Mouser Electronics

Authorized Distributor

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